# Temperature & Humidity Test PC3-P200

Report No: 03S019A0

Report Date : April 21, 2003

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QA Lab Reliability test

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# PC3-P200 System Configuration Entry Report No.03S019A0

QA Lab Reliability test

Item	Specification / Component		
СРИ	Embedded VIA C3 Eden 667 MHz		
Memory	168pin DIMM socket x 2 Up to 1GB SDRAM		
Hard disk drive	One 2.5" drive		
Storage device One slim CD-ROM built-in			
SSD	One internal Compact Flash Type II socket		
I/O Ports	4 COM ports, 1 parallel port, 2 USB ports, PS/2 mouse and K/B, Mic-in/Line-in/Line-out, VGA port		
Expansion One PISA slot (Optional)			
Network (LAN)	10/100base-T Ethernet		
Audio Interface	Speaker out, CD-input, Line-in, Line-out, Mic-in		
Speakers build-in	Speaker-connector (1.3W)		
Power supply	DC input with an power adapter –Lien Electronic LE-9702B-06		
Display	12.1" 800 x 600 TFT LCD		
Housing	Plastic		
Dimension (W x H x D)	340mm x 269.3mm x 68.5mm		
Weight	3.25kg		
T/S option	Analog resistive		
Battery pack option	Smart Li-ion 3S2P 10.8V 4000mAh		

# **Test Item List**

#### QA Lab Reliability test

Num	Test item	Result	Remark
1	High temperature operation test	Passed	
2	Low temperature operation test	Passed	
3	High temperature & humidity storage test	Passed	
4	Low temperature storage test	Passed	
5	Humidity test	Passed	
6	Temperature cycle test	Passed	
7	Thermal profile test	Passed	
8	Cold start test	Passed	

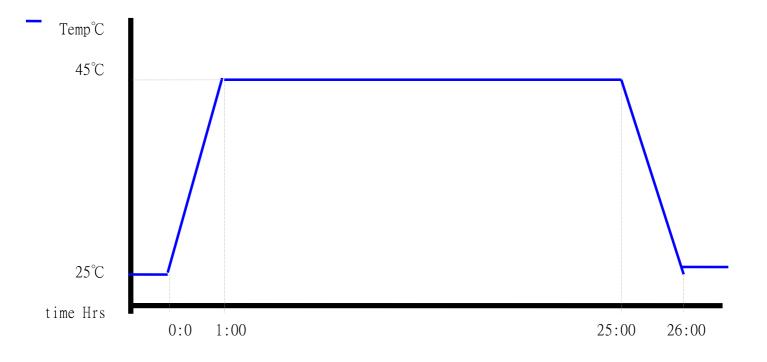
# PC3-P200 High Temp. Operation Test Report No.03S019A0

QA Lab Reliability test

Test Date :March 21, 2002 ~ March 22, 2002Test Site :Advantech QA Environment LabPerformed By : Jeff Yang

**Test Standard :** Reference IEC68-2-2 Testing procedures Test Bb : Dry Heat Test

- 1. Test Temperature :  $45^{\circ}$ C
- 2. Test Times : 24Hrs
- 3. Test Software : Windows media Player (Video test soft-MPEG form HDD)
- 4. Test Environment Curve :



Test Equipment : Programmable Temperature & Humidity Chamber K.SON. INS. TECH CORP. Model : THS-DL4 +-150 Date of Calibration : 07/06/2001

#### Sample Configuration & Quantity Under Test :

Using one PC3-P200 panel PC with the following options installed: 1.CPU : VIA C3 Eden 667 MHz 2. Chipsets : S3 VIA Wister T PN133T

VIA VT82C686B

- 3. LAN : RTL 8139C
- 4. RAM : Kingstone KVR133X64C3 256MB
- 5. HDD : Fujitsu MHH2060AT 6.0G

#### **Performance Criteria :**

Electronic function check:

- 1. All system functions must be checked with appropriate testing programs and should pass the inspection.
- 2. Running Win98 for OS, the system should not have degradation in its performance.

Mechanical function check:

- 1. The cover and connectors should work properly without any interference.
- 2. All screws should be tightened up appropriately.

#### **Test Result :**

There is no damage in electronic and mechanical functions. Degradation has not been found. Performance is maintained with no incurable physical damage or degradation.

#### **Conclusion :**

**Passed.** The PC3-P200 panel PC meets high temperature operation test.

#### Photo:



**PC3-P200 high temperature operation test** 

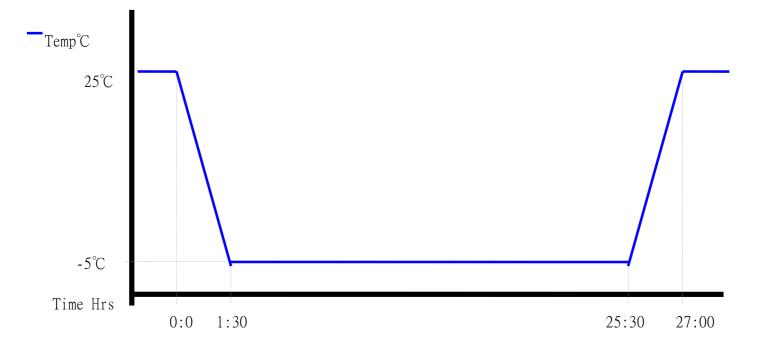
### PC3-P200 Low Temp. Operation Test Report No.03S019A0

QA Lab Reliability test

Test Date :March 22, 2002 ~ March 24, 2002Test Site :Advantech QA Environment LabPerformed By :Jeff Yang

**Test Standard :** Reference IEC68-2-1 Testing procedures Test Ab : Cold Test

- 1. Test Temperature :  $-5^{\circ}C$
- 2. Test Times : 24Hrs
- 1. Test Software : Windows media Player (Video test soft-MPEG form HDD)
- 4. Test Environment Curve :



### Low Temp. Operation Test Report No.03S019A0

#### QA Lab Reliability test

Test Equipment : Programmable Temperature & Humidity Chamber K.SON. INS. TECH CORP. Model : THS-DL4 +-150 Date of Calibration : 07/06/2001

#### Sample Configuration & Quantity Under Test :

Using one PC3-P200 panel PC with the following options installed: 1.CPU : VIA C3 Eden 667 MHz 2. Chipsets : S3 VIA Wister T PN133T

VIA VT82C686B

- 3. LAN : RTL 8139C
- 4. RAM : Kingstone KVR133X64C3 256MB
- 5. HDD : Fujitsu MHH2060AT 6.0G

#### **Performance Criteria :**

Electronic function check:

- 1. All system functions must be checked with appropriate testing programs and should pass the inspection.
- 2. Running Win98 for OS, the system should not have degradation in its performance.

Mechanical function check:

- 1. The cover and connectors should work properly without any interference.
- 2. All screws should be tightened up appropriately.

#### **Test Result :**

There is no damage in electronic and mechanical functions. Degradation has not been found. Performance is maintained with no incurable physical damage or degradation.

# Low Temp. Operation Test Report No.03S019A0

#### QA Lab Reliability test

#### **Conclusion :**

**Passed.** The PC3-P200 panel PC meets low temperature operation test.

#### Photo:



**PC3-P200** low temperature operation test

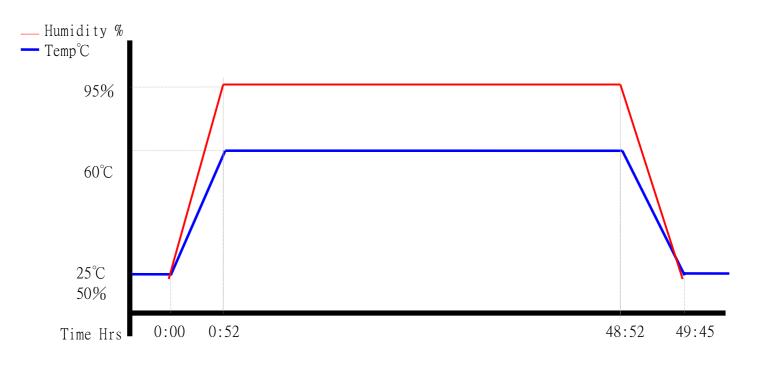
### PC3-P200 High Temp. & Humidity Storage Test Report No.03S019A0

QA Lab Reliability test

Test Date :June 01, 2002 ~ June 03, 2002Test Site :Advantech QA Environment LabPerformed By : Jeff Yang

**Test Standard :** Reference IEC68-2-56 Testing procedures Test Cb : Damp Heat Steady State Test

- 1. Test Temperature :  $60^{\circ}$ C
- 2. Test Humidity : 95%
- 3. Test Times : 48Hrs
- 4. Test Software : Windows media Player (Video test soft-MPEG form HDD)
- 5. Test Environment Curve :



### PC3-P200 High Temp. & Humidity Storage Test Report No.03S019A0

QA Lab Reliability test

Test Equipment : Programmable Temperature & Humidity Chamber K.SON. INS. Tech. Corp. Model : THS-DL4+-100 Date of Calibration : 05/21/2002

#### Sample Configuration & Quantity Under Test :

Using one PC3-P200 panel PC with the following options installed: 1.CPU : VIA C3 Eden 667 MHz 2. Chipsets : S3 VIA Wister T PN133T VIA VT82C686B 3. LAN : RTL 8139C 4. RAM : Kingstone KVR133X64C3 256MB 5. HDD : Fujitsu MHH2060AT 6.0G

#### **Performance Criteria :**

Electronic function check:

- 1. All system functions must be checked with appropriate testing programs and should pass the inspection.
- 2. Running Win98 for OS, the system should not have degradation in its performance.

Mechanical function check:

- 1. The cover and connectors should work properly without any interference.
- 2. All screws should be tightened up appropriately.

#### **Test Result :**

There is no damage in electronic and mechanical functions. Degradation has not been found.

Performance is maintained with no incurable physical damage or degradation.

#### **Conclusion :**

#### Passed.

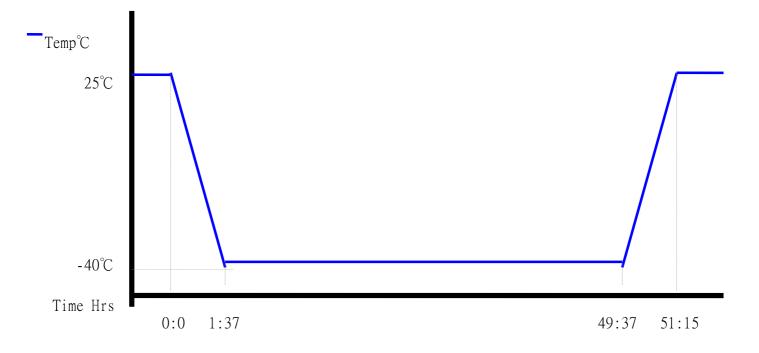
The PC3-P200 panel PC meets high temperature & humidity storage test.

#### QA Lab Reliability test

Test Date :May 29, 2002 ~ May 31, 2002Test Site :Advantech QA Environment LabPerformed By : Jeff Yang

**Test Standard :** Reference IEC68-2-1 Testing procedures Test Ab : Cold Test

- 1. Test Temperature : -40°C
- 2. Test Times : 48Hrs
- 3. Test Software : Windows media Player (Video test soft-MPEG form HDD)
- 4. Test Environment Curve :



#### QA Lab Reliability test

Test Equipment : Programmable Temperature & Humidity Chamber K.SON. INS. Tech. Corp. Model : THS-DL4+- 100 Date of Calibration : 05/21/2002

#### Sample Configuration & Quantity Under Test :

Using one PC3-P200 panel PC with the following options installed:

1.CPU : VIA C3 Eden 667 MHz

2. Chipsets : S3 VIA Wister T PN133T VIA VT82C686B

- 3. LAN : RTL 8139C
- 4. RAM : Kingstone KVR133X64C3 256MB
- 5. HDD : Fujitsu MHH2060AT 6.0G

#### **Performance Criteria :**

Electronic function check:

- 1. All system functions must be checked with appropriate testing programs and should pass the inspection.
- 2. Running Win98 for OS, the system should not have degradation in its performance.

Mechanical function check:

- 1. The cover and connectors should work properly without any interference.
- 2. All screws should be tightened up appropriately.

#### **Test Result :**

There is no damage in electronic and mechanical functions.

Degradation has not been found.

Performance is maintained with no incurable physical damage or degradation.

#### **Conclusion :**

#### Passed.

The PC3-P200 panel PC meets low temperature storage test.

### **Humidity Test**

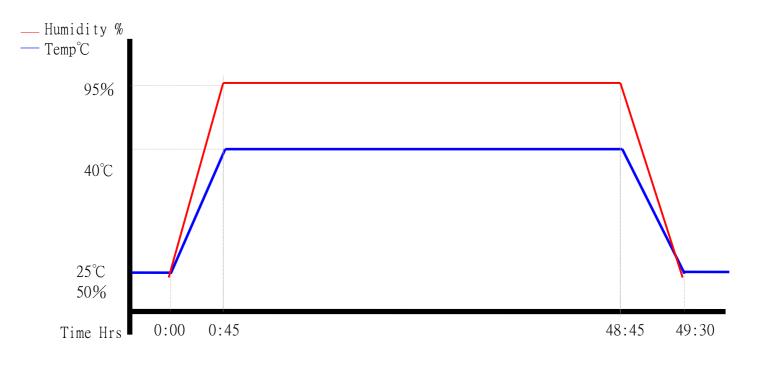
### PC3-P200

QA Lab Reliability test

Test Date :April 01, 2002 ~ April 03, 2002Test Site :Advantech QA Environment LabPerformed By : Jeff Yang

**Test Standard :** Reference IEC68-2-3 Testing procedures Test Cb : Damp Heat steady state Test

- 1. Test Temperature :  $40^{\circ}$ C
- 2. Test Humidity : 95%
- 3. Test Times : 48Hrs
- 4. Test Software : Windows media Player (Video test soft-MPEG form HDD)
- 5. Test Environment Curve :



Test Equipment : Programmable Temperature & Humidity Chamber K.SON. INS. TECH CORP. Model : THS-DL4 +-150 Date of Calibration : 07/06/2001

#### Sample Configuration & Quantity Under Test :

Using one PC3-P200 panel PC with the following options installed: 1.CPU : VIA C3 Eden 667 MHz 2. Chipsets : S3 VIA Wister T PN133T VIA VT82C686B 3. LAN : RTL 8139C 4. RAM : Kingstone KVR133X64C3 256MB 5. HDD : Fujitsu MHH2060AT 6.0G

#### **Performance Criteria :**

Electronic function check:

- 1. All system functions must be checked with appropriate testing programs and should pass the inspection.
- 2. Running Win98 for OS, the system should not have degradation in its performance.

Mechanical function check:

- 1. The cover and connectors should work properly without any interference.
- 2. All screws should be tightened up appropriately.

#### **Test Result :**

There is no damage in electronic and mechanical functions. Degradation has not been found.

Performance is maintained with no incurable physical damage or degradation.

#### **Conclusion :**

#### Passed.

The PC3-P200 panel PC meets humidity operation test.

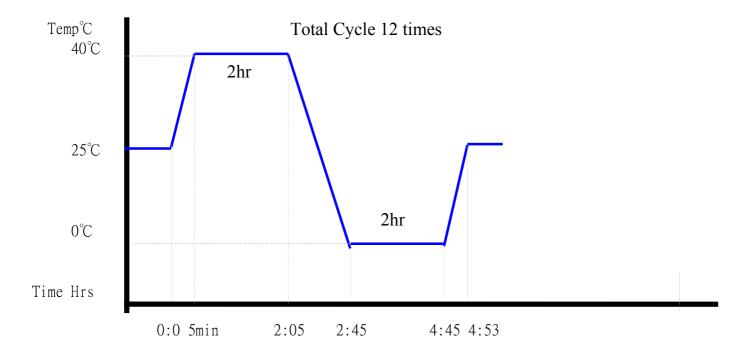
### PC3-P200 Temperature Cycle Test Report No.03S019A0

QA Lab Reliability test

Test Date :April 05, 2002 ~ April 08, 2002Test Site :Advantech QA Environment LabPerformed By :Jeff Yang

**Test Standard :** Reference IEC68-2-14 Testing procedures Test N : Chang of temperature test

- 1. Test High Temperature : 40°C
- 2. Test Low Temperature :  $0^{\circ}$ C
- 3. Test Dwell Times : Each temperature 2 hours
- 4. Temperature Slope : heating  $3^{\circ}$ C per min , cooling  $1^{\circ}$ C per min
- 5. Test Times : 12 cycle
- 6. Test Software : Windows media Player (Video test soft-MPEG form HDD)
- 7. Test Environment Curve :



#### QA Lab Reliability test

Test Equipment : Programmable Temperature & Humidity Chamber K.SON. INS. TECH CORP. Model : THS-DL4 +-150 Date of Calibration : 07/06/2001

#### Sample Configuration & Quantity Under Test :

Using one PC3-P200 panel PC with the following options installed: 1.CPU : VIA C3 Eden 667 MHz 2. Chipsets : S3 VIA Wister T PN133T

- VIA VT82C686B
- 3. LAN : RTL 8139C
- 4. RAM : Kingstone KVR133X64C3 256MB
- 5. HDD : Fujitsu MHH2060AT 6.0G

#### **Performance Criteria :**

Electronic function check:

- 1. All system functions must be checked with appropriate testing programs and should pass the inspection.
- 2. Running Win98 for OS, the system should not have degradation in its performance.

Mechanical function check:

- 1. The cover and connectors should work properly without any interference.
- 2. All screws should be tightened up appropriately.

#### **Test Result :**

There is no damage in electronic and mechanical functions.

Degradation has not been found.

Performance is maintained with no incurable physical damage or degradation.

#### **Conclusion :**

#### Passed.

The PC3-P200 panel PC meets temperature cycle test.

**PC3-P200** 

Test Date :March 19,2002Test Site :Advantech QA Environment LabPerformed By :Jeff Yang

**Test Standard :** Reference IEC68-2-2 Testing procedures Test Bb : Dry Heat Test

#### **Test Condition :**

- 1. Test Temperature :  $25^{\circ}$ C, $40^{\circ}$ C
- 2. Test Times : Each temperature 6Hrs
- 3. Test Software : Windows media Player (Video test soft-MPEG form HDD)

Test Equipment : Programmable Temperature & Humidity Chamber K.SON. INS. Tech. Corp.. Model : TES-D4L +-150 Date of Calibration : 08/10/2001

> DATA LOGGER OMEGA CO. LTD. Model : OM-5100 S/N : 9412-0404 Date of Calibration : 09/19/2001

#### Sample Configuration & Quantity Under Test :

Using one PC3-P200 panel PC with the following options installed: 1.CPU : VIA C3 Eden 667 MHz

- 2. Chipsets : S3 VIA Wister T PN133T VIA VT82C686B
- 3. LAN : RTL 8139C
- 4. RAM : Kingstone KVR133X64C3 256MB
- 5. HDD : Fujitsu MHH2060AT 6.0G

#### **Performance Criteria :**

Electronic function check:

- 1. All system functions must be checked with appropriate testing programs and should pass the inspection.
- 2. Running Win98 for OS, the system should not have degradation in its performance.

Mechanical function check:

- 1. The cover and connectors should work properly without any interference.
- 2. All screws should be tightened up appropriately.

#### Test Data :

NUM	Parts List	25°C	40°C	Remark
1	VIA C3 667MHz CPU heatsink	61.0	75.7	
2	S3-VIA heatsink	52.0	66.5	
3	VIA VT82C68613	53.9	67.1	
4	ICS 9248CF-98	73.4	87.1	
5	EXILINX	64.9	78.2	
6	RTL 8139C lan chip	45.9	59.8	
7	Inverter transformer	49.7	62.8	
8	Power supply coil	52.7	68.8	
9	HDD-Fujistu MHIV2100AT	47.3	60.3	
10	System air temperature	41.0	56.4	

#### **Test Result :**

There is no damage in electronic and mechanical functions. Degradation has not been found.

Performance is maintained with no incurable physical damage or degradation.

#### **Conclusion :**

#### Passed.

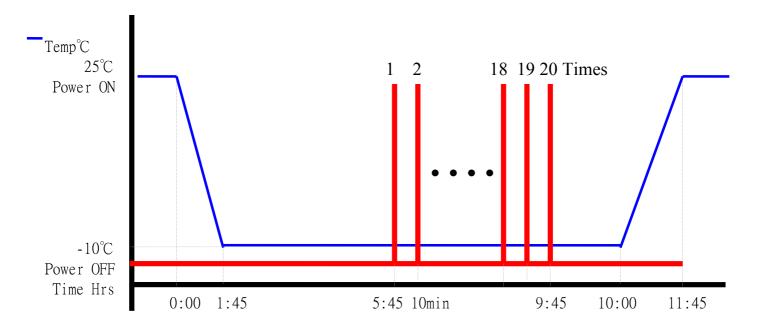
The PC3-P200 panel PC meets Thermal profile test.

QA Lab Reliability test

Test Date :July 01,2002 ~ July 02,2002Test Site :Advantech QA Environment LabPerformed By : Jeff Yang

**Test Standard :** Reference IEC68-2-1 Testing procedures Test Ab : Cold Test

- 1. Test Temperature :  $-10^{\circ}$ C
- 2. Test Times : 8Hrs
  - Step: A.System power off 4 hours.
    - B.System power on , then 2 minutes later, system power off.
    - C.After 10 minutes, system power on again.
    - D.Two minutes later, system power off again.
    - E.Recycle step C& D for 20 times.
- 3. Number of test : 20 times
- 4. Test Software : MS-DOS
- 5. Test Environment Curve :



Test Equipment : Programmable Temperature & Humidity Chamber K.SON. INS. TECH CORP. Model : TES-D4L +-150 Date of Calibration : 05/20/2002

#### Sample Configuration & Quantity Under Test :

Using one PC3-P200 panel PC with the following options installed: 1.CPU : VIA C3 Eden 667 MHz 2. Chipsets : S3 VIA Wister T PN133T VIA VT82C686B

- 3. LAN : RTL 8139C
- 4. RAM : Kingstone KVR133X64C3 256MB
- 5. HDD : Fujitsu MHH2060AT 6.0G

#### **Performance Criteria :**

Electronic function check:

- 1. All system functions must be checked with appropriate testing programs and should pass the inspection.
- 2. Running Win98 for OS, the system should not have degradation in its performance.

Mechanical function check:

- 1. The cover and connectors should work properly without any interference.
- 2. All screws should be tightened up appropriately.

#### **Test Result :**

There is no damage in electronic and mechanical functions. Degradation has not been found. Performance is maintained with no incurable physical damage or degradation.

#### **Conclusion :**

#### Passed.

The PC3-P200 panel PC meets cold start test.